

Single N-channel MOSFET

ELM13402CA-S

■General description

ELM13402CA-S uses advanced trench technology to provide excellent $R_{ds(on)}$, low gate charge and low gate resistance.

■Features

- $V_{ds}=30V$
- $I_d=4A$ ($V_{gs}=10V$)
- $R_{ds(on)} < 55m\Omega$ ($V_{gs}=10V$)
- $R_{ds(on)} < 70m\Omega$ ($V_{gs}=4.5V$)
- $R_{ds(on)} < 110m\Omega$ ($V_{gs}=2.5V$)

■Maximum absolute ratings

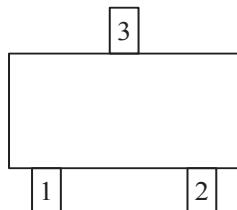
Parameter	Symbol	Limit	Unit	Note
Drain-source voltage	V_{ds}	30	V	
Gate-source voltage	V_{gs}	± 12	V	
Continuous drain current	I_d	4.0	A	1
		3.4		
Pulsed drain current	I_{dm}	15	A	2
Power dissipation	P_d	1.4	W	1
		1.0		
Junction and storage temperature range	T_j, T_{stg}	-55 to 150	°C	

■Thermal characteristics

Parameter		Symbol	Typ.	Max.	Unit	Note
Maximum junction-to-ambient	$t \leq 10s$	$R_{\theta ja}$	70	90	°C/W	1
Maximum junction-to-ambient	Steady-state		100	125	°C/W	
Maximum junction-to-lead	Steady-state	$R_{\theta jl}$	63	80	°C/W	3

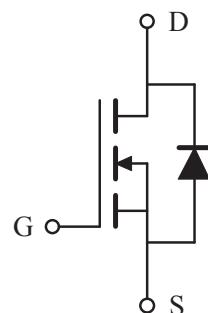
■Pin configuration

SOT-23(TOP VIEW)



Pin No.	Pin name
1	GATE
2	SOURCE
3	DRAIN

■Circuit



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■Electrical characteristics

$T_a=25^\circ C$

Parameter	Symbol	Condition		Min.	Typ.	Max.	Unit
STATIC PARAMETERS							
Drain-source breakdown voltage	BV_{DSS}	$I_D=250\mu A, V_{GS}=0V$		30			V
Zero gate voltage drain current	Id_{SS}	$V_{DS}=24V, V_{GS}=0V$			1		μA
			$T_j=55^\circ C$			5	
Gate-body leakage current	I_{GSS}	$V_{DS}=0V, V_{GS}=\pm 12V$				100	nA
Gate threshold voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$		0.6	1.0	1.4	V
On state drain current	$I_{D(on)}$	$V_{GS}=4.5V, V_{DS}=5V$		10			A
Static drain-source on-resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=4A$			45	55	$m\Omega$
			$T_j=125^\circ C$		66	80	
		$V_{GS}=4.5V, I_D=3A$			55	70	$m\Omega$
		$V_{GS}=2.5V, I_D=2A$			83	110	$m\Omega$
Forward transconductance	G_{FS}	$V_{DS}=5V, I_D=4A$			8		S
Diode forward voltage	V_{SD}	$I_S=1A, V_{GS}=0V$			0.8	1.0	V
Max. body-diode continuous current	I_S					2.5	A
DYNAMIC PARAMETERS							
Input capacitance	C_{ISS}	$V_{GS}=0V, V_{DS}=15V, f=1MHz$			390.0		pF
Output capacitance	C_{OSS}				54.5		pF
Reverse transfer capacitance	C_{RSS}				41.0		pF
Gate resistance	R_g	$V_{GS}=0V, V_{DS}=0V, f=1MHz$			3		Ω
SWITCHING PARAMETERS							
Total gate charge	Q_g	$V_{GS}=4.5V, V_{DS}=15V, I_D=4A$			4.34		nC
Gate-source charge	Q_{GS}				0.60		nC
Gate-drain charge	Q_{GD}				1.38		nC
Turn-on delay time	$t_{d(on)}$	$V_{GS}=10V, V_{DS}=15V$ $R_L=3.75\Omega, R_{GEN}=6\Omega$			3.3		ns
Turn-on rise time	t_r				1.0		ns
Turn-off delay time	$t_{d(off)}$				21.7		ns
Turn-off fall time	t_f				2.1		ns
Body diode reverse recovery time	t_{rr}	$I_F=4A, dI/dt=100A/\mu s$			12.0		ns
Body diode reverse recovery charge	Q_{rr}	$I_F=4A, dI/dt=100A/\mu s$			6.3		nC

NOTE :

1. The value of $R_{\theta ja}$ is measured with the device mounted on 1in² FR-4 board of 2oz. Copper, in still air environment with $T_a=25^\circ C$. The value in any given applications depends on the user's specific board design. The current rating is based on the $t \leq 10s$ thermal resistance rating.
2. Repetitive rating, pulse width limited by junction temperature.
3. The $R_{\theta ja}$ is the sum of the thermal impedance from junction to lead $R_{\theta jl}$ and lead to ambient.
4. The static characteristics in Figures 1 to 6 are obtained using 80 μs pulses, duty cycle 0.5%max.
5. These tests are performed with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_a=25^\circ C$. The SOA curve provides a single pulse rating.



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■ Typical electrical and thermal characteristics

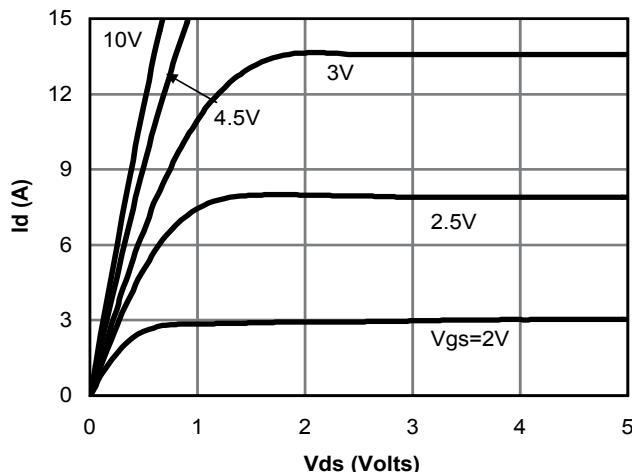


Fig 1: On-Region Characteristics

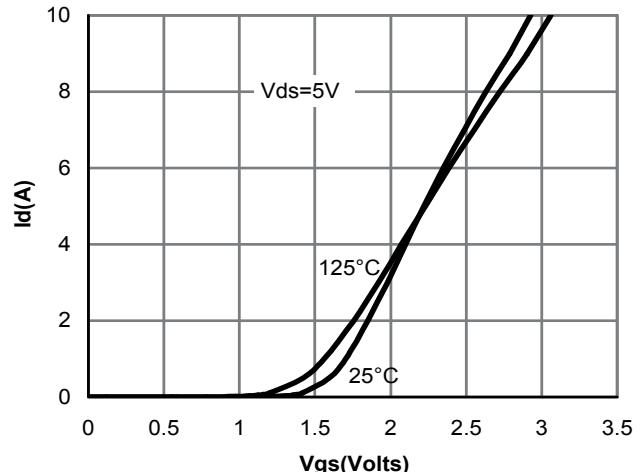


Figure 2: Transfer Characteristics

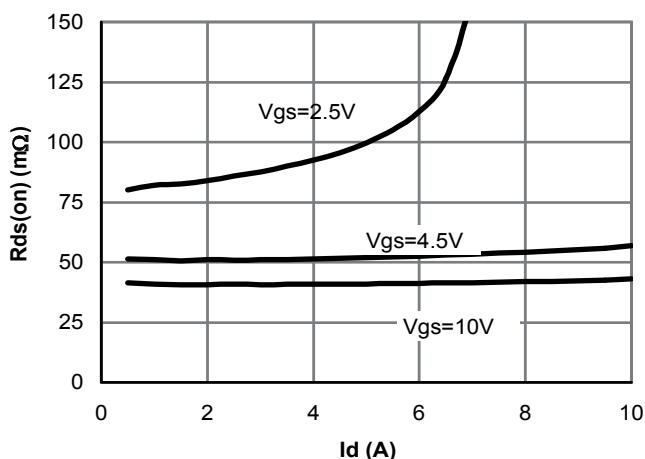


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

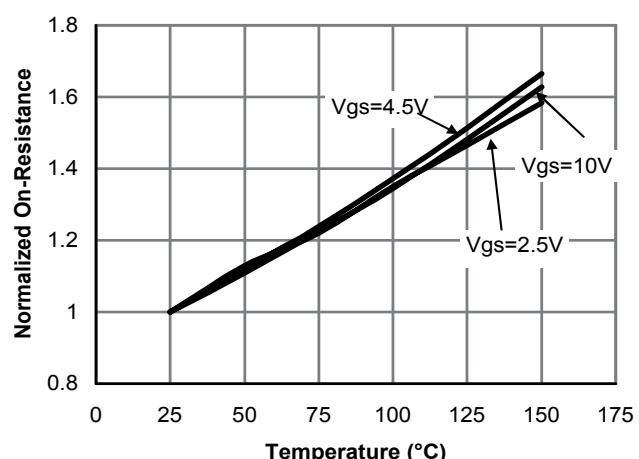


Figure 4: On-Resistance vs. Junction Temperature

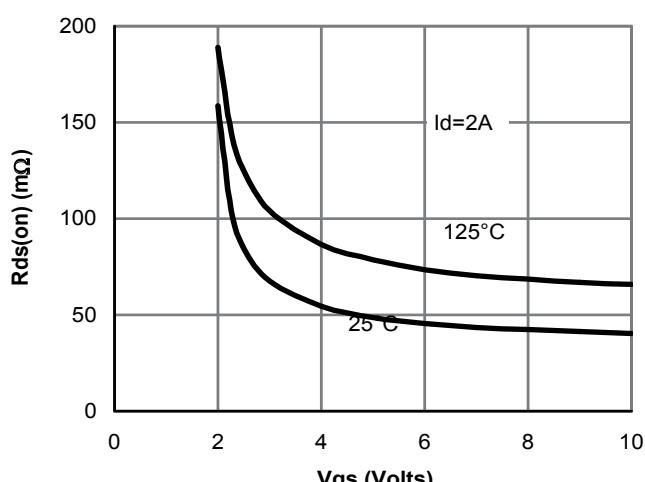


Figure 5: On-Resistance vs. Gate-Source Voltage

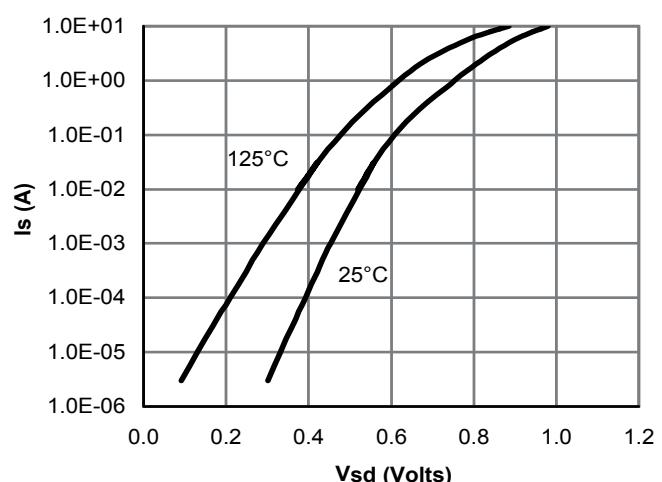


Figure 6: Body-Diode Characteristics

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